

ABSTRACT

The present invention relates to: a copper nanoparticle-containing composition containing copper nanoparticles A, a monocarboxylic acid B, and an organic solvent C, wherein the monocarboxylic acid B has 5 or more and 12 or less carbons, and the monocarboxylic acid B has one or more functional groups or bonds selected from the group consisting of a hydroxy group, a ketonic carbonyl group, and an ether bond; a method for producing a bonded body using the copper nanoparticle-containing composition; and a bonded body or an electronic device using the copper nanoparticle-containing composition.